



1/11/5

01-14-2005



102920942

FORM PTO-1595
(Rev. 10/02)

RECORDATION FOR

MENT OF COMMERCE
nt and Trademark Office

Docket No.: 67161-218

PATENTS

To the Honorable Commissioner for Patents and Trademarks: Please record the attached original documents or copy thereto:

1. Name of Conveying Party(ies):

Takeshi HAMAMOTO, Hidenori MITANI, Taku OGURA

Additional name(s) of conveying party(ies) attached? ☐ Yes ☐ No

3. Nature of Conveyance:

☒ Assignment

☐ Merger

☐ Security Agreement

☐ Change of Name

☐ Other

Execution Date: December 2, 2004, December 2, 2004, December 2, 2004

2. Name and address of receiving party(ies):

Name: RENESAS TECHNOLOGY CORP.

Address: 4-1, Marunouchi 2-chome,

Chiyoda-ku

Tokyo, 100-6334 JAPAN

Additional name(s) & address(es) attached? ☐ Yes ☐ No

4. Application number(s) or patent number(s):

If the document is being filed together with a new application, the execution date of the application is:

A. Patent Application No(s).

10/941,028, filed on September 15, 2004.

B. Patent No(s).

Additional numbers attached? ☐ Yes ☐ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: MCDERMOTT WILL & EMERY LLP

Internal Address:

Street Address: 600 13th Street, N.W.

City: Washington State: D. C. Zip: 20005-3096

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41)

\$40.00

☐ Enclosed

☒ Authorized to be charged to deposit account

8. Deposit account number:

500417

DO NOT USE THIS SPACE

9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Stephen A. Becker, 26,527

January 11, 2005

Name and Registration No. of Person Signing

Signature

Date

Total number of pages including cover sheet: 3

OMB No. 0651-0027 (exp. 6/30/2005)

01/13/2005 6TUN11 00000079 500417 10941028

01 FC:8021

40.00 BA

PATENT
REEL: 016146 FRAME: 0413

ASSIGNMENT

WHEREAS, Takeshi HAMAMOTO, Hidenori MITANI and Taku OGURA,

hereinafter called the "Assignors," have jointly invented a new and useful invention entitled Nonvolatile Semiconductor Memory Device Including High Efficiency and Low Cost Redundant Structure, for which he has:

- (a) filed an application for United States Letters Patent on September 15, 2004 as (Serial No. 10/941,028); or
- (b) executed an application for United States Letters Patent on _____; or
- (c) filed a provisional application on _____ as (Serial No. _____); and

WHEREAS, Renesas Technology Corp., a corporation organized and existing under the laws of Japan, having a place of business at: 4-1, Marunouchi 2-chome, Chiyoda-ku, TOKYO 100-6334, JAPAN, hereinafter called the "Assignee," is desirous of acquiring the entire right, title and interest in and to said invention, the application above identified, and in, to and under any Letters Patent which may be obtained to said invention, as hereinafter more fully set forth;

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN, be it known that for and in consideration of the sum of One Dollar (\$1.00), and other valuable and legally sufficient considerations, the receipt of which by said Assignors from the said Assignee is hereby acknowledged, the said Assignors have sold, assigned and transferred, and by these presents do sell, assign and transfer unto the said Assignee, the entire, right, title and interest for the United States in and to the invention and application hereinabove identified, and any Letters Patent of the United States that may issue for said invention, together with the entire right, title and interest in and to said invention and applications for Letters Patent and Letters Patent therefor, in all countries foreign to the United States, including the full right to claim for any such application all benefits and priority rights under any applicable convention; to have and to hold for the sole and exclusive use and benefit of the said Assignee, its successors and assigns, to the full end of the term or terms for which any and all of said Letters Patent for said inventions may issue.

And the said Assignors do hereby covenant and agree, for himself and his legal representatives, that he will assist the said Assignee in the prosecution of the application herein identified; in the making and prosecution of any other applications for Letters Patent that the said Assignee may elect to make covering the invention herein identified, as hereinabove set forth; in vesting in the said Assignee like exclusive title in and to all such other applications and Letters Patent; and in the prosecution of any interference which may arise involving said invention, or any application or Letters Patent herein contemplated; and that they will execute and deliver to the said Assignee any and all additional papers which may be requested by the said Assignee to fully carry out the terms of this Assignment.

The undersigned hereby grant(s) the attorneys of McDermott, Will & Emery LLP the power to insert on this Assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

And the Commissioner of Patents and Trademarks is hereby authorized and requested to issue Letters Patent to the said Assignee in accordance with the terms of this Assignment.

IN TESTIMONY WHEREOF, the said Assignors have hereunto set his hands and affixed his seal.

Date: December 2, 2004
(Seal)

Takeshi Hamamoto
Takeshi HAMAMOTO

Date: December 2, 2004
(Seal)

Hidenori Mitani
Hidenori MITANI

Date: December 2, 2004
(Seal)

Taku Ogura
Taku OGURA

Date: _____
(Seal)

Date: _____
(Seal)
